

Description

The AL3565 is a Power Management Integrated Chip (PMIC) with three programmable DC-DC converters via a simple one wire digital control to power supply bias 500mA AMOLED (Active Matrix Organic Light Emitting Diode) panel requiring three supply rails, VPOS, VNEG and AVDD.

The device integrates a buck-boost converter for V_{POS}, an inverting buck-boost converter for V_{NEG}, and a boost converter for AV_{DD}, which are suitable for power management of portable products operated under lithium-ion battery power.

The PRG (Programming Digital Control) pin allows programming the VPOS and VNEG output voltage in steps of 100mV, and AVDD in steps of 300mV. The AL3565 offers an excellent line and load regulation.

The AL3565 is available in U-QFN3030-16 (Type B) (3.0mm x 3.0mm) 16-pin package with exposed pad. Please contact us for WL-CSP and other package options.

Features

- Wide Input Voltage Range: 2.9V to 4.8V
- -40°C to + 85°C Operating Ambient Temperature
- VPOS Buck-Boost Converter (Default 4.6V)
- 4.6V to 5.4V, Programmable Output Voltage
 - 100mV Step Size
- Up to 500mA Output Current
 - 0.5% Accuracy
- AV_{DD} Boost Converter (Default 6.1V)
 - 5.8V to 7.9V, Programmable Output Voltage
 - 300mV Step Size
 - 100mA Output Current
 - 0.5% Accuracy
- V_{NEG} Inverting Buck-Boost Converter (Default -2.5V)
 - -1.4V to -5.4V, Programmable Negative Voltage
 - 100mV Step Size
 - Up to 500mA Output Current
 - 0.5% Accuracy
- Excellent Line and Transient Regulations
- Short-Circuit Protection (SCP)
- Thermal Shutdown Protection
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>
- Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 - 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Pin Assignments



U-QFN3030-16 (Type B)

Applications

AMOLED display panel power supply bias



AL3565

Typical Applications Circuits



Pin Descriptions

Pin Number	Pin Name	Description
1	SW1	Boost converter switch pin
2	PGND1	Boost converter power ground
3	Vpos	Boost converter output (VPOS)
4	FBS	Boost converter sense pin
5	FD	Fast Discharge circuit function selection. High level enables the fast discharge function; low level sets VPOS, VNEG and AVDD high impedance without output.
6	СТ	Must tie to ground
7	AGND	Analog ground
8	EN	Enable boost converter (AV _{DD})
9	PRG	Programming control pin, digital control VPOS, VNEG and AVDD output voltage
10	Vneg	Inverting buck-boost output (V _{NEG})
11	SW3	Inverting buck-boost switching pin
12	VINP	Inverting buck-boost converter power stage supply voltage
13	AVDD	Boost converter output voltage pin (AV _{DD})
14	PGND2	Boost converter power ground
15	SW2	Boost converter switching pin
16	VINA	Supply voltage for the device
—	Exposed Pad	Connect to the Ground layers on the PCB



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Functional Block Diagram





Absolute Maximum Ratings

Symbol	Parameter	Ratings	Unit
VINP, VINA	Supply pin voltage	-0.3 to 6.5	
SW1	Switch pin voltage	-0.3 to 6.5	
FBS	Feedback sense pin voltage	-0.3 to 6.5	
SW2	Switch pin voltage	-0.3 to 12.0	
V _{POS}	V _{POS} pin voltage	-0.3 to 6.5	V
AV _{DD}	AV _{DD} pin voltage	-0.3 to 12.0	V
V _{NEG}	V _{NEG} pin voltage	-6.5 to 0.3	
SW3	Switch pin voltage	-6.5 to 6.5	
PRG, EN, FD	PRG, EN, FD pin voltage	-0.3 to 6.5	
СТ	CT pin voltage	-0.3 to 6.5	
TJ	Operating junction temperature	-40 to +150	°C
T _{ST}	Storage temperature	-65 to +150	C

Caution: Stresses greater than those listed under Absolute Maximum Ratings can cause permanent damage to the device. These are stress ratings only, and Subsequences that the series that the series of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to *Absolute Maximum Ratings* for extended periods can affect device reliability. Semiconductor devices are ESD sensitive and may be damaged by exposure to ESD events. Suitable ESD precautions should be taken when handling and transporting these devices.

ESD Ratings

Symbol	Parameter		Value	Unit
Vesd	Electrostatio disoborgo	Human body model ESD protection	±2000	V
	Electrostatic discharge	Charge device mode ESD protection	1000	V

Package Thermal Data

Package	θ _{JC} Thermal Resistance Junction-to-Case	θ _{JA} Thermal Resistance Junction-to-Ambient	Pois Ta = +25°C, Tj = +125°C
U-QFN3030-16 (Type B)	3.3°C/W	42.9°C/W (Note 4)	1.5W

Recommended Operating Conditions

Symbol	Parameter	Min	Мах	Unit
VIN	Input supply voltage range	2.9	4.8	V
T _A	Operating ambient temperature range	-40	+85	°C

4. Test condition for U-QFN3030-16 (Type B): device mounted on 25.4mm x 25.4mm FR-4 PCB (10mm x 10mm 1oz copper, minimum recommended pad Note: layout on top layer and thermal vias to bottom layer ground plane). For better thermal performance, larger copper pad for heatsink is needed.



Electrical Characteristics (V_{IN} = 3.7V, PRG = 3.7V, EN = 3.7V, V_{POS} = 4.6V, V_{NEG} = -2.5V, AV_{DD} = 6.1V, T_A = -40°C to +85°C, typical values are at T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Input Suppl	y Section	I					
Vin	Input voltage	—	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	2.9	3.7	4.8	V
		V _{IN} falling	_	2.7	_	2.8	V
VUVLO	Undervoltage lockout threshold	VIN rising	—	2.75		2.86	V
Isd	Shutdown current	PRG = GND, EN = GND, su	m of current flowing into VINA	_	0.3	1	μA
VPOS - BOO	st/Buck-Boost Converter						
1100 200		Default voltage	_		4.6		V
			$T_A = +25^{\circ}C$, No load	-0.5	_	0.5	%
Vvpos	V _{POS} voltage	Output accuracy	$T_A = -40^{\circ}C$ to +85°C, No load	-0.8	_	0.8	%
		Output range (100mV/step)	—	4.6	_	5.0	V
R _{DS(on)1N}	Switch on-resistance (nMOS)	L 000 A	_	_	250	_	mΩ
R _{DS(on)1P}	Rectifier on-resistance (pMOS)	$I_{(SW1)} = 200 \text{mA}$	_	_	350	_	mΩ
fsw1	Switching frequency	I _{VPOS} = 500mA	—		1.5	_	MHz
I _{SW1}	Switch current limit	Inductor peak current	—	1.1	1.4	1.8	А
VSCP_VPOS	Short-circuit threshold in operation	Percentage of VPOS	—	—	90	_	%
tscp_vpos	Short-circuit detection time in operation	—	—	—	1	—	ms
M		FBS increasing	—	200	300	400	mV
VT	FBS sense threshold	FBS decreasing	—	100	200	300	mV
RDCHG1	Discharge resistance	PRG = GND, FD = V _{IN} Ivpos = 1mA	—		70	_	Ω
VRIPPLE_ VPOS	V _{POS} output voltage ripple	V _{IN} = 3.7V, V _{POS} = 4.6V I _{POS} = 500mA	—	_	20	_	mV
ILEAK_VPOS	VPOS and FBS leakage, no discharge	FD = GND, PRG = GND	V _{POS} ≤ V _{IN}	_	0.1		μA
	Line regulation	I _{POS} = 500mA	_	_	0.03	_	%/V
	Les el menule l'en	V _{IN} = 3.7V	100mA ≤ I _{POS} ≤ 500mA	_	0.08	_	0//0
	Load regulation	$0mA \le I_{POS} \le 500mA$	$0mA \le I_{POS} \le 500mA$	_	0.1	_	%/A
AV _{DD} – Boo	st Converter						
		Default voltage	_	_	7.6	_	V
VAVOD	Vavoo voltage		T _A = +25°C, No load	-0.5	_	0.5	%
VAVDD	VAVDD Voltage		$T_A = -40^{\circ}C$ to +85°C, No load	-1.0	_	1.0	%
		Output range (300mV/step)	—	5.8	—	7.9	V
R _{DS(on)2N}	Switch on-resistance (nMOS)	$l(sw_2) = 100 \text{mA}$	—	—	300	_	mΩ
RDS(on)2P	Rectifier on-resistance (pMOS)		—	—	450		mΩ
f _{SW2}	Switching frequency	I _{AVDD} = 100mA	—	_	1.5		MHz
VSCP_AVDD	Short-circuit threshold in operation	Percentage of nominal	_	—	90	_	%
tscp_avdd	Short-circuit detection time in operation	_	_	—	1		ms
I _{SW2}	Switch current limit	Inductor peak current	—	0.45	0.65	0.85	A
Vripple_ avdd	AV _{DD} output voltage ripple	$V_{IN} = 3.7V, AV_{DD} = 7.6V$ $I_{AVDD} = 100mA$	—	—	20	—	mV
ILEAK_AVDD	AV _{DD} leakage, no discharge	FD = GND, EN = GND	AV _{DD} ≤ V _{IN}	_	0.3		μA
R _{DCHG2}	Discharge resistance	$EN = GND, FD = V_{IN}$ $I_{AVDD} = 1mA$	—	_	70	_	Ω
—	Line regulation	IAVDD = 30mA	_	_	0.05	—	%/V
	Lood regulation	0mA < 1	$50mA \le I_{AVDD} \le 100mA$	_	0.5		0/ / ^
	Load regulation	$UmA \le I_{AVDD} \le 100mA$	$0mA \le I_{AVDD} \le 100mA$	_	0.5	_	70/A



Electrical Characteristics (V_{IN} = 3.7V, PRG = 3.7V, EN = 3.7V, V_{POS} = 4.6V, V_{NEG} = -2.5V, AV_{DD} = 6.1V, T_A = -40°C to +85°C, typical values are at T_A = +25°C, unless otherwise specified.) (continued)

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{NEG} – Inverting Buck-Boost Converter							
		Default voltage	—		-4.0	_	V
N/	V _{VNEG} voltage		T _A = +25°C	-0.5	_	0.5	%
VVNEG		Output accuracy	$T_A = -40^{\circ}C$ to $+85^{\circ}C$	-0.8	_	0.8	%
		Output range (100mV/step)	_	-1.4	_	-5.4	V
RDS(on)3P	Switch on-resistance (pMOS)		_	_	200		mΩ
R _{DS(on)3N}	Rectifier on-resistance (nMOS)	$I_{(SW3)} = 200 \text{mA}$	_	_	300	_	mΩ
fswз	Switching frequency	INEG = 500mA	_	_	1.5		MHz
I _{SW3}	Switch current limit	Inductor peak current	_	1.5	2.0	2.75	А
VSCP VNEG	Short-circuit threshold in operation	Voltage increase from nominal V _{NEG}	_	_	530		mV
VOOI _VINEO	Short-circuit threshold in startup	—	_	_	250	_	mV
toop vare	Short-circuit detection time in operation	_			1		ms
ISCP_VNEG	Short-circuit detection time in startup		_	_	10		ms
ILEAK_VNEG	V _{NEG} leakage, no discharge	FD = GND, EN = GND	V _{NEG} = 0V	—	0.1	_	μA
Vripple_ Vneg	V _{NEG} output voltage ripple	Vin = 3.7V, Vneg = -4.0V Iavdd = 500mA	_	_	20	_	mV
R _{DCHG3}	Discharge resistance	PRG = GND, FD = V _{IN} I _{VNEG} = 1mA	_	—	70	—	Ω
_	Line regulation	INEG = 500mA	—	_	0.03	_	%/V
	Lood regulation	V _{NEG} = -5V 1mA ≤ I _{NEG} ≤ 500mA	$100mA \le I_{NEG} \le 500mA$	_	1.6	_	0/ / Δ
			1mA ≤ I _{NEG} ≤ 500mA		2.0		70/A
Logic Interf	ace (PRG, EN, FD)						
Vін	Logic input high level voltage	—		1.2			V
VIL	Logic input low level voltage	—	—			0.4	V
R	Pulldown resistance	—		250	500	900	kΩ
Other							
TSHDN	Thermal shutdown	Junction temperature			+150		°C
T _{HYS}	Thermal shutdown hysteresis	—	—	_	+10	_	°C
PRG Timing	Interface Section (PRG, EN, FD)					
tinit	Initialization time				300	_	μs
t STORE	Data storage time			30	_	80	μs
tLOW	Low-level pulse duration			2	10	25	μs
thigh	High-level pulse duration			2	10	25	μs
tOFF	Shutdown time			30	_	80	μs



Performance Characteristics (VIN = 3.7V, TA = +25°C with components as Figure 20, unless otherwise specified.)



VPOS = 4.6V, VNEG = -4V, EN = LOW, PRG = HIGH



Test conditions: VIN = 3.7V, No Load, PRG = HIGH, EN = LOW





V_{POS} V_{NEG} with Fast Discharge (FD) = ON





Performance Characteristics (VIN = 3.7V, TA = +25°C with components as Figure 20, unless otherwise specified.) (continued)



Test conditions: VPOS Boost, VPOS = 4.6V / 100mA load

VPOS Boost, VPOS = 4.6V / 300mA load

Test conditions: V_{POS} Boost, V_{POS} = 4.6V / 500mA load





 $V_{NEG} = -4.0V / 500mA load$



Output Current Figure 12. Switch Pin, V_{NEG} Output Ripple, Inductor & Output Current

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Test conditions: V_{NEG} = -4.0V / 300mA load

$V_{NEG} = -4.0V / 100mA load$





Performance Characteristics (VIN = 3.7V, TA = +25°C with components as Figure 20, unless otherwise specified.) (continued)



 $AV_{DD} = 7.6V / 100mA load$





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Function Description

The AL3565 consists of two boost converters and an inverting buck-boost converter. The V_{POS}, V_{NEG} and AV_{DD} outputs are all programmable through the PRG digital pin. The V_{POS} output range is from 4.6V to 5.0V, default 4.6V. The V_{NEG} output range is from -5.4V to -1.4V, default -2.5V. The AV_{DD} output range is from 5.8V to 7.9V, default 6.1V. Fast discharge function is on/off controlled by FD pin

1.0 Startup Sequence, Soft-Start and Shutdown

The device features a soft-start function to limit the inrush current. The AV_{DD} boost converter is enabled when EN goes high. When PRG goes high, the V_{POS} boost/buck-boost converter starts and 10ms later the inverting buck-boost converter (V_{NEG}) starts with its default value. The typical startup sequence with fast discharge is shown in Figure 15. The AV_{DD} boost converter, and the V_{POS} boost converter operate independently. The AV_{DD} boost converter does not require the V_{POS} boost converter to be in regulation in order for it to start.

Before the first startup, the output discharge is undefined and the output discharge is activated by PRG rising edge, following the FD configuration. When the converters shut down, the outputs are discharged if FD function is enabled or the outputs are high impedance if FD function is disabled.



Figure 15. Startup and Shutdown Sequence with Fast Discharge



Figure 16. Startup and Shutdown Sequence Without Fast Discharge



1.1 Programming VPOS, VNEG and AVDD Output Voltage through PRG Pin

All the output voltage of AL3565 can be programmed through PRG pin. If programming is not required the PRG pin can also be used as a standard enable pin. Once the device is enabled, AL3565 starts with its default values. The interface counts the rising edges applied to the PRG pin and sets the new values. Table 1 to 3 listed the mapping for the rising edge numbers and the corresponding the output voltage.

The settings are stored in a volatile memory, they are reset as follows:

- A power cycle resets all settings to default values.
- Enabling the VPos boost/buck-boost converter sets the output discharge. (The output discharge function is controlled by FD pin.)
- If PRG is low for a min. toFF, VNEG will be reset to default value and VPOS will be reset to default value.
- If EN and PRG are low at the same time for min. toFF, AVDD will be reset to its default value. If EN is low and PRG is high, AVDD retains its programmed value.



Figure 17. Digital Interface Using PRG Pin



2.0 VPOS – Boost/Buck-Boost Converter

The boost/buck-boost converter VPOS uses a fixed-frequency current-mode topology. Its default output voltage VPOS is (4.6V) for AL3565. VPOS can be programmed through the digital PRG pin. For higher output voltage accuracy, connect the output sense pin (FBS) directly to the positive terminal of the main output capacitor. If not used, the FBS pin shall be tied to ground.

2.1 VPOS – Asynchronous Buck-Boost Mode

When VPOS is close to VIN, AL3565 enters asynchronous buck-boost mode. In this mode, the high-side power pMOS channel is turned off completely and the power pMOS body diode is used for the conduction.

2.2 VPOS - Boost Converter, Output Sense (FBS pin)

The positive output boost circuitry has a dedicated output pin (FBS). If FBS is floating or tied to ground, the positive output boost circuitry senses the output through the VPOs pin.

2.3 VPOS Voltage Control by PRG Pin

When the PRG pin is pulled high while the device is enabled, VPOS will rise to its default voltage of 4.6V. While the device is enabled, the digital programming interface counts the number of rising edges applied to the PRG pin. Table 1 shows the pulse count for a corresponding programmed VPOS voltage. VPOS can be programmed in 100mV steps.

Bit / Rising Edges	VPOS
Default	4.6V
54	4.7V
55	4.8V
56	4.9V
57	5.0V
64	4.6V

Table 1. Programing Table for AL3565 VPOS



3.0 AV_{DD} – Boost Converter

Boost converter uses a fixed-frequency current-mode topology. Its default output voltage AV_{DD} is (6.1V) for AL3565. AV_{DD} can be programmed through the digital PRG pin.

3.1 AV_{DD} Voltage Control by PRG Pin

Once the device is enabled using the EN pin, AV_{DD} will rise to its default value. While the device is enabled, the digital programming interface counts the number of rising edges applied to the PRG pin. Table 2 shows the pulse count for a corresponding programmed AV_{DD} voltage. AV_{DD} can be programmed in 300mV steps.

Bit / Rising Edges	AVDD
Default	7.6V
42	7.9V
43	7.6V
44	7.3V
45	7.0V
46	6.7V
47	6.4V
48	6.1V
49	5.8V

Table 2. Programing Table for AL3565 AVDD



4.0 V_{NEG} – Inverting Buck-Boost Converter

The inverting buck-boost converter uses a peak current PWM control topology. Its default output voltage V_{NEG} is (-2.5V) for AL3565. V_{NEG} can be programmed through the digital PRG pin.

4.1 VNEG Voltage Control by PRG Pin

When the PRG pin is pulled high while the device is enabled, V_{NEG} will fall to its default value. While the device is enabled, the digital programming interface counts the number of rising edges applied to the PRG pin. Table 3 shows the pulse count for a corresponding programmed V_{NEG} voltage. V_{NEG} can be programmed in 100mV steps.

Bit / Rising Edges	VVNEG	Bit / Rising Edges	VVNEG
Default	-4.0V	21	-3.4V
1	-5.4 V	22	-3.3V
2	-5.3 V	23	-3.2V
3	-5.2 V	24	-3.1V
4	-5.1V	25	-3.0V
5	-5.0V	26	-2.9V
6	-4.9V	27	-2.8V
7	-4.8V	28	-2.7V
8	-4.7V	29	-2.6V
9	-4.6V	30	-2.5V
10	-4.5V	31	-2.4V
11	-4.4V	32	-2.3V
12	-4.3V	33	-2.2V
13	-4.2V	34	-2.1V
14	-4.1V	35	-2.0V
15	-4.0V	36	-1.9V
16	-3.9V	37	-1.8V
17	-3.8V	38	-1.7V
18	-3.7V	39	-1.6V
19	-3.6V	40	-1.5V
20	-3.5V	41	-1.4V

Table 3. Programing Table for AL3565 VNEG



5.0 FD Control

When PRG is pulled high, the fast discharge (FD) function will be initialized to its default state according to the FD pin. If the FD pin is connected to GND, fast discharge is disabled and all outputs are high impedance. If the FD pin is connected to HIGH (HIGH > 1.2V), fast discharge is enabled and all outputs are discharged.

The fast discharge function can also be controlled through the PRG pin, which would override the FD pin connection setting. Table 4 shows the pulse rising edges count for a corresponding programmed FD function (ON/OFF).

Bit / Rising Edges	FD Pin	FD	Comment
Defeult / 0	HIGH	ON	Using FD pin
Default / 0	GND	OFF	Using FD pin
50	Х	ON	Using PRG pin
51	Х	OFF	Using PRG pin

Table 4. Programming	Table for FI	O Control
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Only in the "Yellow Highlighted" area, we can use pulses applied to PRG pin to disable/enable fast discharge, no matter how FD pin is configured. As shown, V_{NEG} always needs Fast Discharge active at power-up.







Figure 19. Without Fast Discharge sequence with FD = low, but discharge can be enabled by PRG (Table 4) in yellow highlighted area

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Function Description (continued)

6.0 Short-Circuit Protection (SCP)

AL3565 detects short and shuts down in one of the below conditions:

- AV_{DD} falls below 90% of its programmed voltage for more than 1ms after power-up: shutdown VPOS/VNEG/AV_{DD}
- VPOS falls below 90% of its programmed voltage for more than 1ms after power-up: shutdown VPOS/VNEG/AVDD
- VNEG rises above 500mV of its programmed voltage longer than 1ms: shutdown VPOs/VNEG/ AVDD
- VNEG > 200mV (during startup) when VNEG is enabled (10ms after PRG = HIGH): shutdown VPOs and VNEG only

The shutdown state is latched, and the input and outputs are disconnected. To restart the device, V_{IN} must cycle below UVLO or EN and PRG have to be low at the same time for 80µs (toFF max spec) or longer.

See Section 7 - Inductor/Capacitor Selection for recommended inductor & capacitor values.

6.1 Thermal Shutdown

The AL3565 device enters thermal shutdown if its junction temperature exceeds +150°C (typical). During thermal shutdown none of the device's functions are available, but the programming data is not lost. When the temperature decreases to +140°C (typical), the device automatically restarts performing the startup sequencing with the same voltages and programming as programmed before the thermal shutdown.



Application Information

7.0 Inductor/Capacitor Selection

The AL3565 is designed for supplying power to AMOLED display in smart phone applications. The circuit inputs power from a single-cell Li-ion battery and generates an adjustable power supply AV_{DD}, an adjustable positive output voltage V_{POS} and an adjustable negative output voltage V_{NEG}.

The AV_{DD} boost converter typically requires a 10µH inductor, V_{POS} and V_{NEG} require a 4.7µH. The input and output capacitors are usually ceramic capacitors. Table 5 lists the recommended component for typical circuit configurations. Please contact us for any further components optimizations on either efficiency or sizes.



Figure 20. Typical Application Circuit

The AL3565 is designed to operate with the input voltage ranging from 2.9V to 4.8V. If the input supply is located more than a few centimeters from the AL3565, additional bulk capacitors may be needed. The (4) 10µF (C1) capacitors shown in the typical application circuit are a common choice.

Component	Designator	Value	Part Number	Manufacturer
AV _{DD} inductor	L2	10µH±20%	DFE252012C-100M	ТОКО
VPOS and VNEG inductor	L1, L3	4.7µH±20%	DFE252012F-4R7M	muRata
			DFE252012P-4R7N	токо
V _{IN} capacitor	C1	10µF±20% / 10V / 0805	GRM219R61A106ME47	muRata
AV _{DD} capacitor	C6	22µF±20% / 25V / 0805	CL21A226MPCLRNC	muRata
VPOS capacitor	C2	22µF±20% / 25V / 0805	CL21A226MPCLRNC	muRata
V _{NEG} capacitor	C3, C4	22µF±20% / 25V / 0805 10µF±20% / 25V / 0805	CL21A226MPCLRNC GRM219R61A106ME47	muRata

Table 5. Component Selection Table



Application Information (continued)

8.0 Layout Guidelines

- 1. Place the input capacitor on VINP and the output capacitor on V_{NEG} as close as possible to device. Use short and wide traces to connect the input capacitor on VINP and the output capacitor on V_{NEG}.
- 2. Place the output capacitor on VPOs and AVDD as close as possible to device. Use short and wide traces to connect the output capacitor on VPOs and AVDD.
- 3. Connect the ground of CT capacitor with AGND (pin 7) directly.
- 4. Connect input ground and output ground on the same board layer, not through via hole.
- 5. Connect AGND, PGND1 and PGND2 with exposed thermal pad.

8.1 Layout Example





Design Tools

- Demo Board
- Calculator
- Demo Board Gerber File of PCB Layout Reference
- PSPICE



Ordering Information



DA : U-QFN3030-16 (Type B)

Part Number	Part Number Suffix	Package Code	Package (Note 5)	Packing	
	Fait Number SumA			Qty.	Carrier
AL3565DA-7	-7	DA	U-QFN3030-16 (Type B)	1,500	Tape & Reel

Note: 5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



Part Number	Package	Identification Code
AL3565DA-7	U-QFN3030-16 (Type B)	S9



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



U-QFN3030-16				
Туре В				
Dim	Min	Max	Тур	
Α	0.55	0.65	0.60	
A1	0	0.05	0.02	
A3	-	-	0.15	
b	0.18	0.28	0.23	
D	2.95	3.05	3.00	
D2	1.40	1.60	1.50	
Е	2.95	3.05	3.00	
E2	1.40	1.60	1.50	
е	-	-	0.50	
L	0.35	0.45	0.40	
Z	-	-	0.625	
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



U-QFN3030-16 (Type B)

U-QFN3030-16 (Type B)

Dimensions	Value	
Dimensions	(in mm)	
С	0.500	
G	0.150	
G1	0.150	
Х	0.350	
X1	1.800	
Y	0.600	
Y1	1.800	

Mechanical Data

- Moisture Sensitivity: Level 1 per JESD22-A113
- Terminals: Finish Preplated NiPdAu, Solderable per JESD22-B102 (4)
- Weight: 0.017 grams (Approximate)



Taping Orientation

The taping orientation of other package type can be found on our website at https://www.diodes.com/assets/Packaging-Support-Docs/ap02007.pdf.





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